

PC8141x NSZ Series

AC Input, Low Input Current Type Photocoupler

■ Features

1. Low input current type ($I_F=0.5\text{mA}$)
2. High resistance to noise due to high common rejection voltage (CMR:MIN. $10\text{kV}/\mu\text{s}$)
3. AC input type
4. Compact dual-in line package
5. Isolation voltage (Viso: 5kVrms)
6. Recognized by UL, file No. E64380

■ Applications

1. Programmable controllers
2. Facsimiles
3. Telephones

■ Rank Table

Model No.	Rank mark	I_C (mA)	Conditions
PC81410NSZ	A or no mark	0.25 to 2.0	$I_F=0.5\text{mA}$ $V_{CE}=5\text{V}$ $T_a=25^\circ\text{C}$
PC81411NSZ	A	0.5 to 1.5	

■ Absolute Maximum Ratings ($T_a=25^\circ\text{C}$)

Parameter		Symbol	Rating	Unit
Input	Forward current	I_F	± 10	mA
	*1 Peak forward current	I_{FM}	± 200	mA
	Power dissipation	P	15	mW
Output	Collector-emitter voltage	V_{CEO}	70	V
	Emitter-collector voltage	V_{ECO}	6	V
	Collector current	I_C	50	mA
	Collector power dissipation	P_C	150	mW
	Total power dissipation	P_{tot}	170	mW
Operating temperature		T_{opr}	-30 to $+100$	$^\circ\text{C}$
Storage temperature		T_{stg}	-55 to $+125$	$^\circ\text{C}$
*2 Isolation voltage		V_{iso}	5	kV_{rms}
*3 Soldering temperature		T_{sol}	260	$^\circ\text{C}$

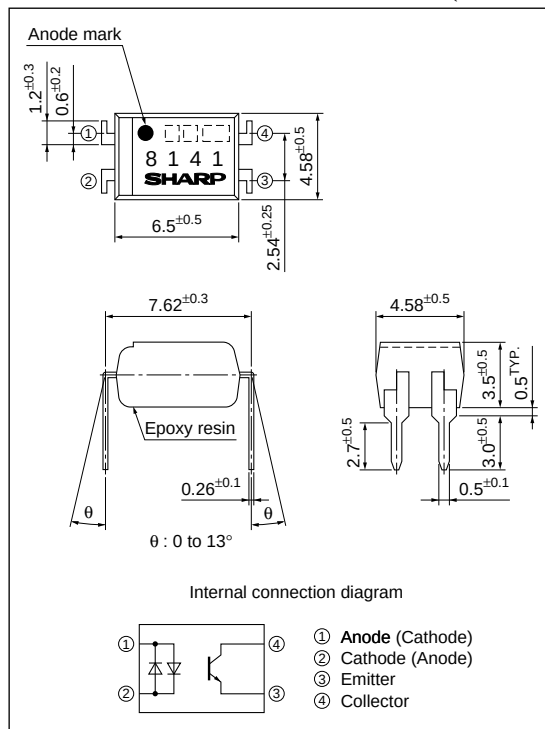
*1 Pulse width $\leq 100\mu\text{s}$, Duty ratio $= 0.001$

*2 40 to 60%RH, AC for 1 minute, $f=60\text{Hz}$

*3 For 10s

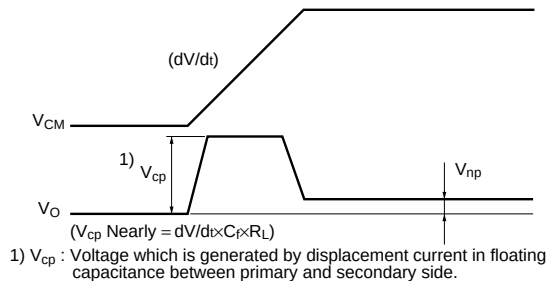
■ Outline Dimensions

(Unit : mm)



($T_a=25^\circ\text{C}$)

*1 Refer to Fig.1.



A line graph showing the forward current I_F in milliamperes (mA) as a function of ambient temperature T_a in degrees Celsius ($^{\circ}\text{C}$). The y-axis is labeled 'Forward current I_F (mA)' and has major ticks at 0, 5, and 10. The x-axis is labeled 'Ambient temperature T_a ($^{\circ}\text{C}$)' and has major ticks at -30, 0, 25, 50, 75, 100, and 125. The graph shows a horizontal line at $I_F = 10$ mA from $T_a = -30$ $^{\circ}\text{C}$ to $T_a = 100$ $^{\circ}\text{C}$. At $T_a = 100$ $^{\circ}\text{C}$, the current drops sharply to 0 mA and remains at 0 mA for higher temperatures.

Ambient temperature T_a ($^{\circ}\text{C}$)	Forward current I_F (mA)
-30	10
0	10
25	10
50	10
75	10
100	10
100	0
125	0

The graph shows the relationship between diode power dissipation P (mW) and ambient temperature T_a (°C). The power dissipation is constant at 15 mW for ambient temperatures from -30 °C to 100 °C. At 100 °C, the power dissipation drops to 0 mW and remains there for higher temperatures.

Ambient temperature T_a (°C)	Diode power dissipation P (mW)
-30	15
0	15
25	15
50	15
75	15
100	15
100	0
125	0

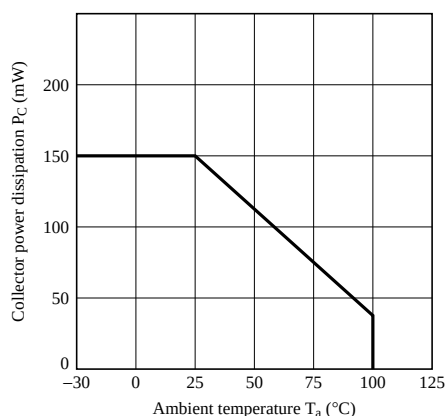
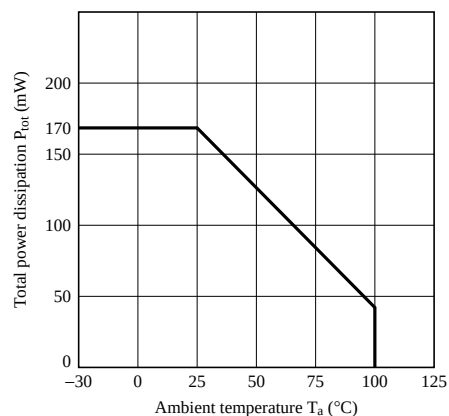
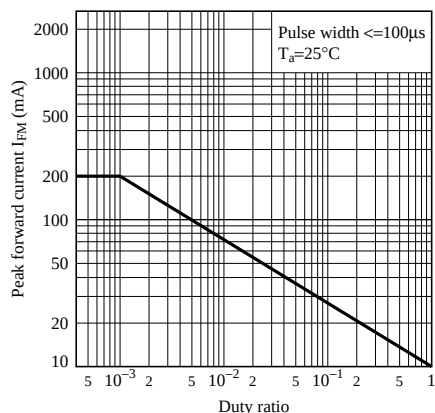
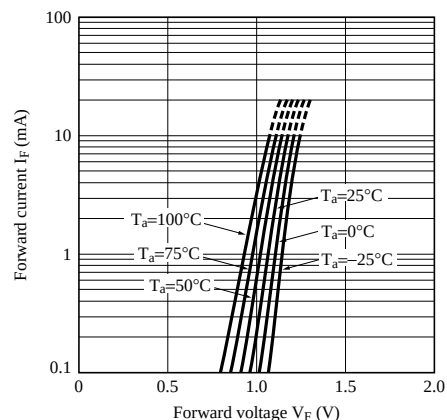
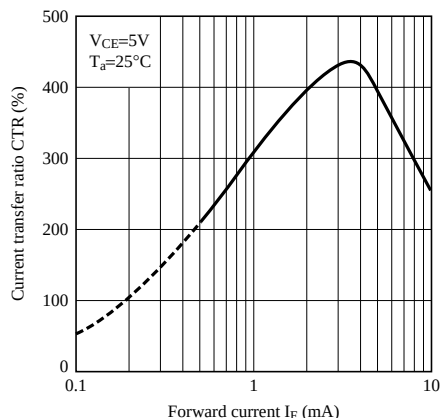
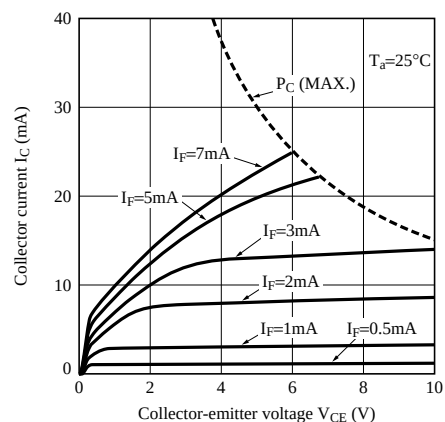
Fig.4 Collector Power Dissipation vs. Ambient Temperature**Fig.5 Total Power Dissipation vs. Ambient Temperature****Fig.6 Peak Forward Current vs. Duty Ratio****Fig.7 Forward Current vs. Forward Voltage****Fig.8 Current Transfer Ratio vs. Forward Current****Fig.9 Collector Current vs. Collector-emitter Voltage**

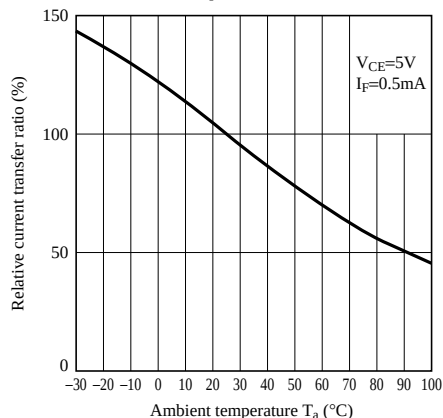
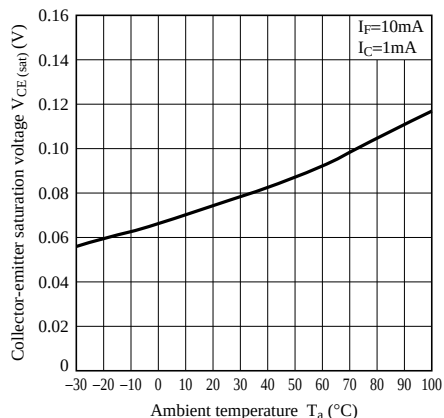
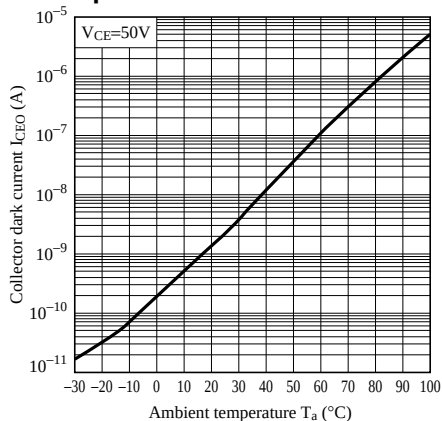
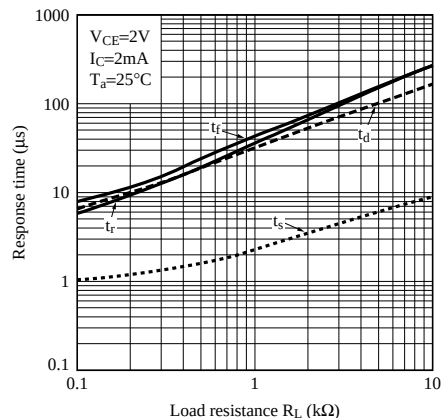
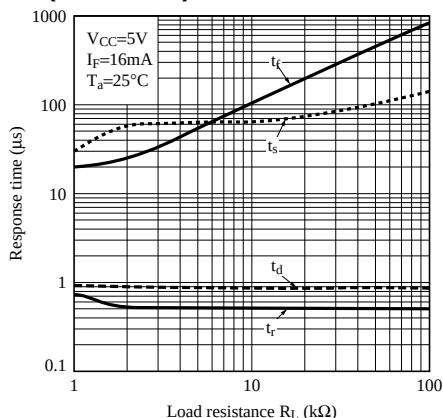
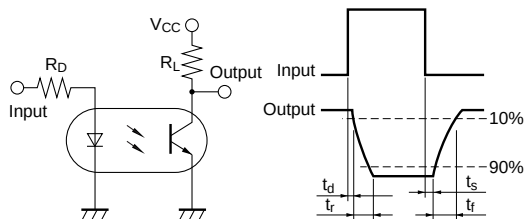
Fig.10 Relative Current Transfer Ratio vs. Ambient Temperature**Fig.11 Collector - emitter Saturation Voltage vs. Ambient Temperature****Fig.12 Collector Dark Current vs. Ambient Temperature****Fig.13 Response Time vs. Load Resistance****Fig.14 Response Time vs. Load Resistance (Saturation)****Fig.15 Test Circuit for Response Time**

Fig.16 Voltage Gain vs Frequency

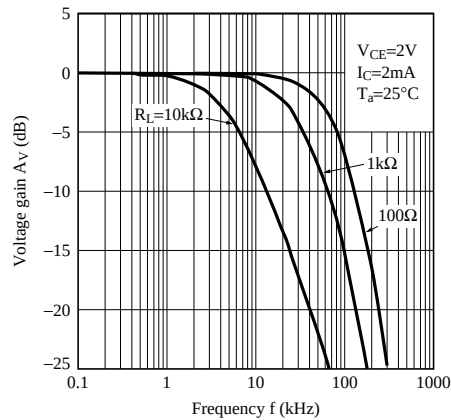


Fig.17 Collector-emitter Saturation Voltage vs. Forward Current

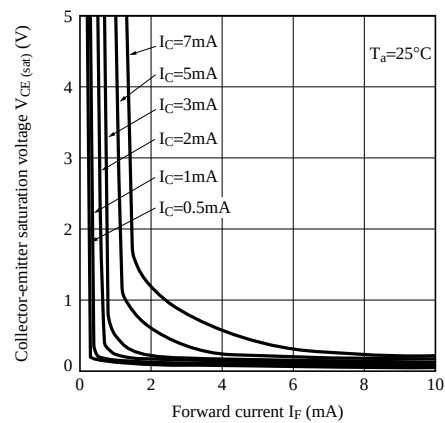


Fig.18 Reflow Soldering

Only one time soldering is recommended within the temperature profile shown below.

